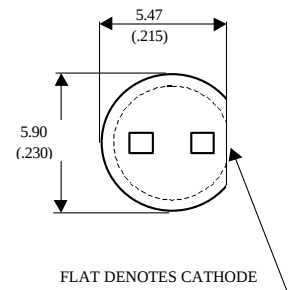


MIE-526A2U

Unit: mm (inches)

Technical drawing of a mechanical part with the following dimensions:

- Top width: $\phi 5.05$ (.200)
- Top height: 7.62 (.300)
- Shoulder height: 1.00 (.040)
- Shaft diameter: 23.4 0MIN. (.920)
- Keyway width: $\square .50$ TYP. (.020)
- Shaft length: 1.00MI (.040)
- Bottom width: 2.54 (.100)



A C

1. Tolerance is ± 0.25 mm (.010") unless otherwise noted.
2. Protruded resin under flange is 1.5 mm (.059") max.
3. Lead spacing is measured where the leads emerge from the package

@ $T_A=25^{\circ}\text{C}$

Parameter	Maximum Rating	Unit
Power Dissipation	120	mW
Peak Forward Current(300pps,10μs pulse)	1	A
Continuos Forward Current	100	mA
Reverse Voltage	5	V
Operating Temperature Range	-55°C to +100°C	
Storage Temperature Range	-55°C to +100°C	
Lead Soldering Temperature	260°C for 5 seconds	

Optical-Electrical Characteristics

@ $T_A = 25^\circ\text{C}$

Parameter	Test Conditions	Symbol	Min.	Typ .	Max.	Unit
Radiant Intensity	$I_F = 20\text{mA}$	I_e		3	-	mW/sr
Forward Voltage	$I_F = 50\text{mA}$	V_F		1.3	1.5	V
	$I_F = 200\text{mA}$			1.65	2.0	
Reverse Current	$V_R = 5\text{V}$	I_R			100	μA
Peak Wavelength	$I_F = 20\text{mA}$	λ		940		nm
Spectral Bandwidth	$I_F = 20\text{mA}$	$\Delta\lambda$		50		nm
View Angle	$I_F = 20\text{mA}$	$2\theta_{1/2}$	-	25	-	deg.

Typical Optical-Electrical Characteristic Curves

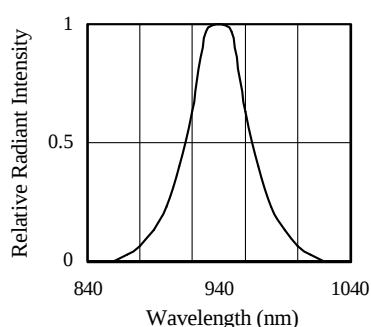


FIG.1 SPECTRAL DISTRIBUTION

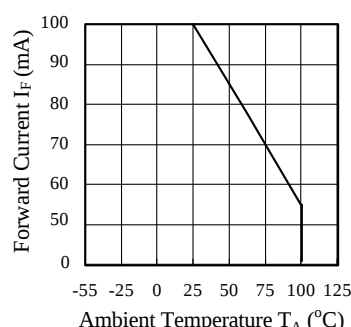


FIG.2 FORWARD CURRENT VS. AMBIENT TEMPERATURE

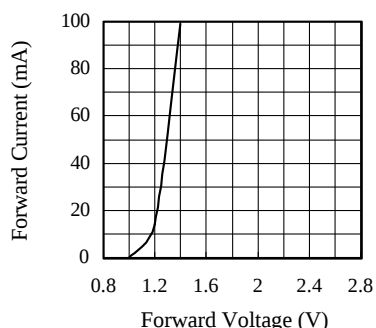


FIG.3 FORWARD CURRENT VS. FORWARD VOLTAGE

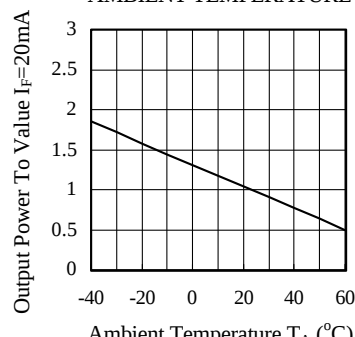


FIG.4 RELATIVE RADIANT INTENSITY VS. AMBIENT TEMPERATURE

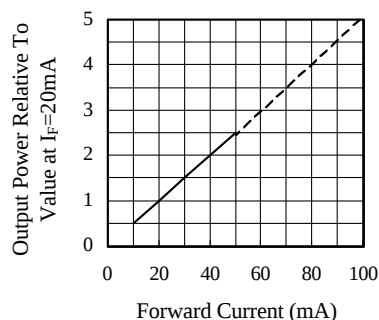


FIG.5 RELATIVE RADIANT INTENSITY VS. FORWARD CURRENT

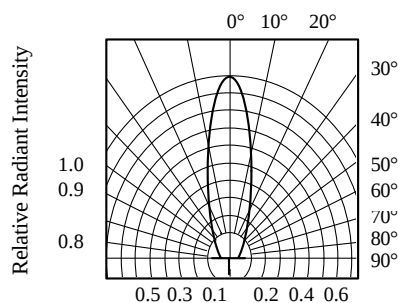


FIG.6 RADIATION DIAGRAM